



PIC12C508A/509A

Errata Sheet for PIC12C508A/509A (Rev. A Silicon)

The PIC12C5XX-parts conform functionally to the PIC12C5XX Data Sheet (DS40139E), except for the anomalies described below:

None

Clarifications/Corrections to the Data Sheet:

In the Device Data Sheet (DS40139E), the following clarifications and corrections should be noted.

Section 13: Corrections for the DC Characteristics, Section 13.2, Section 13.3 and Section 13.4 are shown.

Corrections for the GPIO pull-up resistor ranges are shown in Table 13-1.

For the section titled "Reset", additional information is provided on OSC1/CLKIN and OSC2/CLKOUT pin states during a MCLR.

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13.2 DC CHARACTERISTICS: **PIC12LC508A/509A (Commercial, Industrial)**
PIC12LCE518/519 (Commercial, Industrial)
PIC12LCR509A (Commercial, Industrial)

DC Characteristics Power Supply Pins		Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial)					
Parm No.	Characteristic	Sym	Min	Typ ⁽¹⁾	Max	Units	Conditions
		ΔI_{WDT}	–	2.0 2.0	4 5	μA μA	$V_{DD} = 2.5\text{V}$, Commercial $V_{DD} = 2.5\text{V}$, Industrial

* These parameters are characterized but not tested.

- Note 1:** Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
- 2: This is the limit to which V_{DD} can be lowered in SLEEP mode without losing RAM data.
 - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
 - a) The test conditions for all I_{DD} measurements in active operation mode are:
 $OSC1 =$ external square wave, from rail-to-rail; all I/O pins tristated, pulled to V_{SS} ,
 $T0CKI = V_{DD}$, $MCLR = V_{DD}$; WDT enabled/disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
 - 4: Does not include current through R_{ext} . The current through the resistor can be estimated by the formula:
 $I_R = V_{DD}/2R_{ext}$ (mA) with R_{ext} in kOhm.
 - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to V_{DD} or V_{SS} .

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13.3 DC CHARACTERISTICS: PIC12C508A/509A (Commercial, Industrial, Extended) PIC12CE518/519 (Commercial, Industrial, Extended) PIC12CR509A (Commercial, Industrial, Extended)

Standard Operating Conditions (unless otherwise specified)							
DC CHARACTERISTICS							
Operating temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended)							
Operating voltage V_{DD} range as described in DC spec Section 13.1 and Section 13.2.							
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D040 D040A	Input High Voltage I/O ports with TTL buffer	V_{IH}	2.0V 0.25 V_{DD} + 0.8V	- - -	V_{DD} V_{DD}	V V	$4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$ otherwise
D070	GPIO weak pull-up current (Note 4)	IPUR	30	250	400	μA	$V_{DD} = 5\text{V}, V_{PIN} = V_{SS}$
D061 D061A	Input Leakage Current (Notes 2, 3) GP3/ $\overline{\text{MCLR}}$ (Note 5) GP3/ $\overline{\text{MCLR}}$ (Note 6)	I_{IL}	8 -	130 -	250 ± 5	μA μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$ $V_{SS} \leq V_{PIN} \leq V_{DD}$

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** In EXTRC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC12C5XX be driven with external clock in RC mode.
- 2:** The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as coming out of the pin.
- 4:** Does not include GP3. For GP3 see parameters D0061 and D0061A.
- 5:** This spec. applies to GP3/ $\overline{\text{MCLR}}$ configured as external $\overline{\text{MCLR}}$ and GP3/ $\overline{\text{MCLR}}$ configured as input with internal pull-up enabled.
- 6:** This spec. applies when GP3/ $\overline{\text{MCLR}}$ is configured as an input with pull-up disabled. The leakage current of the $\overline{\text{MCLR}}$ circuit is higher than the standard I/O logic.

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13.4 DC CHARACTERISTICS: **PIC12LC508A/509A (Commercial, Industrial)** **PIC12LCE518/519 (Commercial, Industrial)** **PIC12LCR509A (Commercial, Industrial)**

Standard Operating Conditions (unless otherwise specified) Operating temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) Operating voltage V_{DD} range as described in DC spec Section 13.1 and Section 13.2.							
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D040 D040A	Input High Voltage I/O ports with TTL buffer	V_{IH}	2.0V $0.25V_{DD} + 0.8V$	- - -	V_{DD} V_{DD}	V V	$4.5V \leq V_{DD} \leq 5.5V$ otherwise
D070	GPIO weak pull-up current (Note 4)	I_{PUR}	30	250	400	μA	$V_{DD} = 5V, V_{PIN} = V_{SS}$
D061 D061A	Input Leakage Current (Notes 2, 3) GP3/ $\overline{\text{MCLR}}$ (Note 5) GP3/ $\overline{\text{MCLR}}$ (Note 6)	I_{IL}	8 -	130 -	250 ± 5	μA μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$ $V_{SS} \leq V_{PIN} \leq V_{DD}$

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** In EXTRC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC12C5XX be driven with external clock in RC mode.
- 2:** The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as coming out of the pin.
- 4:** Does not include GP3. For GP3 see parameters D0061 and D0061A.
- 5:** This spec. applies to GP3/ $\overline{\text{MCLR}}$ configured as external $\overline{\text{MCLR}}$ and GP3/ $\overline{\text{MCLR}}$ configured as input with internal pull-up enabled.
- 6:** This spec. applies when GP3/ $\overline{\text{MCLR}}$ is configured as an input with pull-up disabled. The leakage current of the $\overline{\text{MCLR}}$ circuit is higher than the standard I/O logic.

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TABLE 13-1: PULL-UP RESISTOR RANGES* - PIC12C508A, PIC12C509A, PIC12CR509A, PIC12CE518, PIC12CE519, PIC12LC508A, PIC12LC509A, PIC12LCR509A, PIC12LCE518 and PIC12LCE519

VDD (Volts)	Temperature (°C)	Min	Typ	Max	Units
GP0/GP1					
2.5	-40	38K	42K	63K	Ω
	25	42K	48K	63K	Ω
	85	42K	49K	63K	Ω
	125	50K	55K	63K	Ω
5.5	-40	15K	17K	20K	Ω
	25	18K	20K	23K	Ω
	85	19K	22K	25K	Ω
	125	22K	24K	28K	Ω
GP3 ⁽¹⁾					
2.5	-40	65K	80K	850K	Ω
	25	80K	100K	1150K	Ω
	85	85K	110K	1300K	Ω
	125	100K	120K	1500K	Ω
5.5	-40	50K	60K	600K	Ω
	25	60K	65K	750K	Ω
	85	65K	80K	900K	Ω
	125	75K	90K	990K	Ω

* These parameters are characterized but not tested.

Note 1: The weak pull-up resistor and associated current for the GP3/ $\overline{\text{MCLR}}$ pin is non-linear when the respective pin voltage is less than VDD - 1.0V. See parameter D061 for GP3/ $\overline{\text{MCLR}}$ pin current specifications.

Reset

When $\overline{\text{MCLR}}$ is asserted, the state of the OSC1/CLKIN and CLKOUT/OSC2 pins are as follows:

CLKIN/CLKOUT PIN STATES WHEN $\overline{\text{MCLR}}$ ASSERTED

Oscillator Mode	OSC1/CLKIN Pin	OSC2/CLKOUT Pin
EXTRC, CLKOUT on OSC2	OSC1 pin is tristated and driven by external circuit	OSC2 pin is driven low
EXTRC, OSC2 is I/O	OSC1 pin is tristated and driven by external circuit	OSC2 pin is tristate input
INTRC, CLKOUT on OSC2	OSC1 pin is tristate input	OSC2 pin is driven low
INTRC, OSC2 is I/O	OSC1 pin is tristate input	OSC2 pin is tristate input



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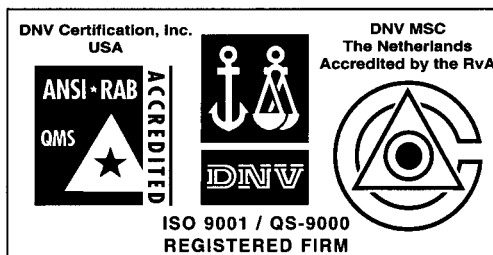
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